Electronic Patent Application Fee Transmittal							
Application Number:	100	10655854					
Filing Date:	05-	05-Sep-2003					
Title of Invention:	Mi	Multi-layer integrated semiconductor structure					
First Named Inventor/Applicant Name:	Rai	Rafael Reif					
Filer:	Ch	Christopher S. Daly					
Attorney Docket Number:	MI	MIT-136AUS					
Filed as Small Entity	•						
Utility under 35 USC 111(a) Filing Fees							
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)		
Basic Filing:					1		
Pages:							
Claims:							
Miscellaneous-Filing:							
Petition:							
Patent-Appeals-and-Interference:							
Post-Allowance-and-Post-Issuance:							
Extension-of-Time:							
Extension - 3 months with \$0 paid		2253	1	555	555		

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
	Total in USD (\$)			555